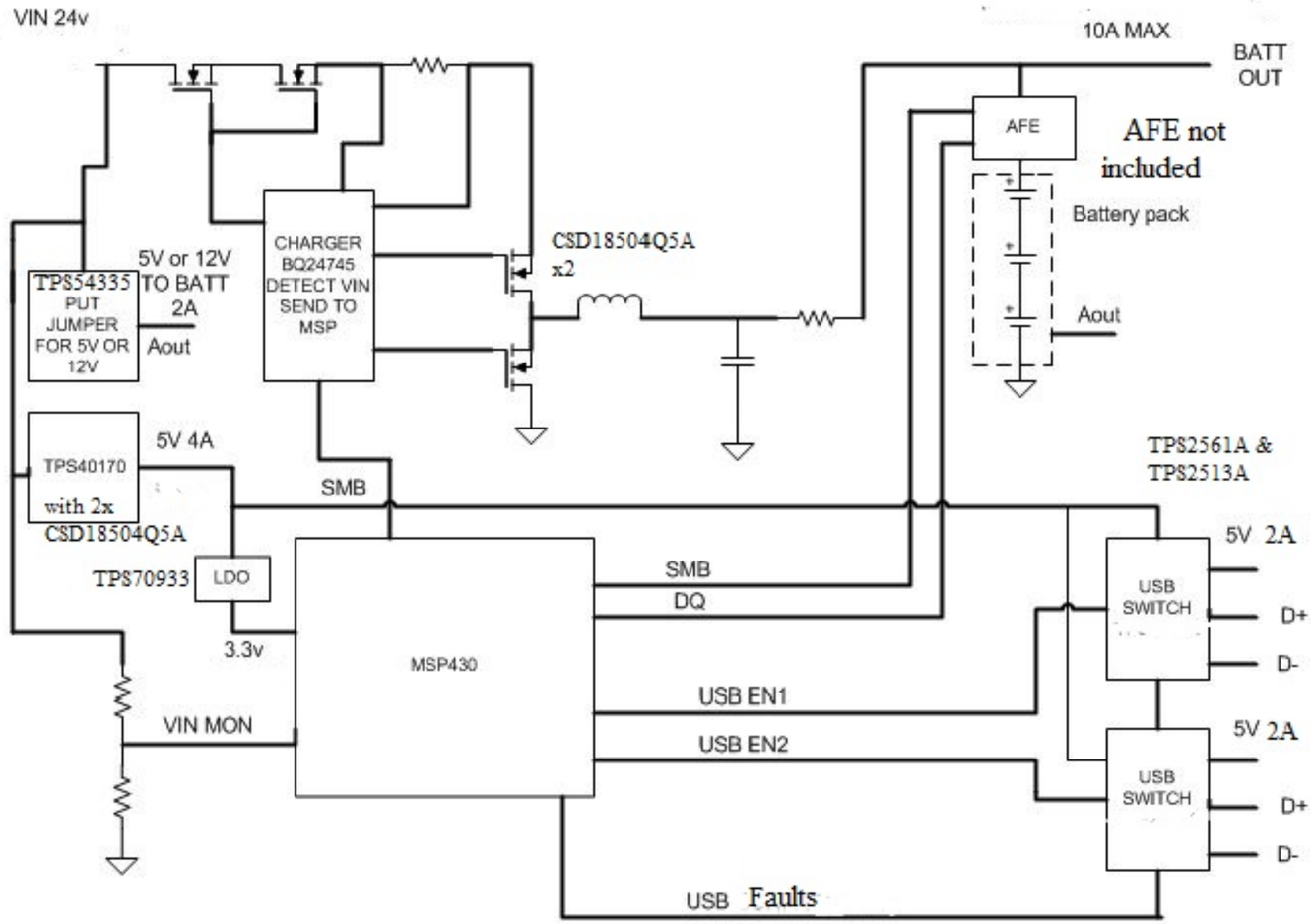
Revision History	
Revision	Notes

Designator
BQ24745_24VtoBatt10A_sch.SchDoc

Designator
5V&12V_sch.SchDoc

Designator
MSP430&USB_sch.SchDoc

Designator
Hardware_PMP9668A_sch.SchDoc



Number: PMP9668	Rev: A	Designed for: Public Release	Mod. Date: 5/20/2015
SVN Rev: Version control disabled		Project Title: Universal Battery Charger 24Vin 10A max	
Drawn By:		Sheet Title:	
Engineer: Josh Mandelcorn		Assembly Variant: 001	Sheet: 1 of 5
		File: Cover Sheet_PMP9668A_sch.SchDoc	Size: B
		Contact: http://www.ti.com/support	

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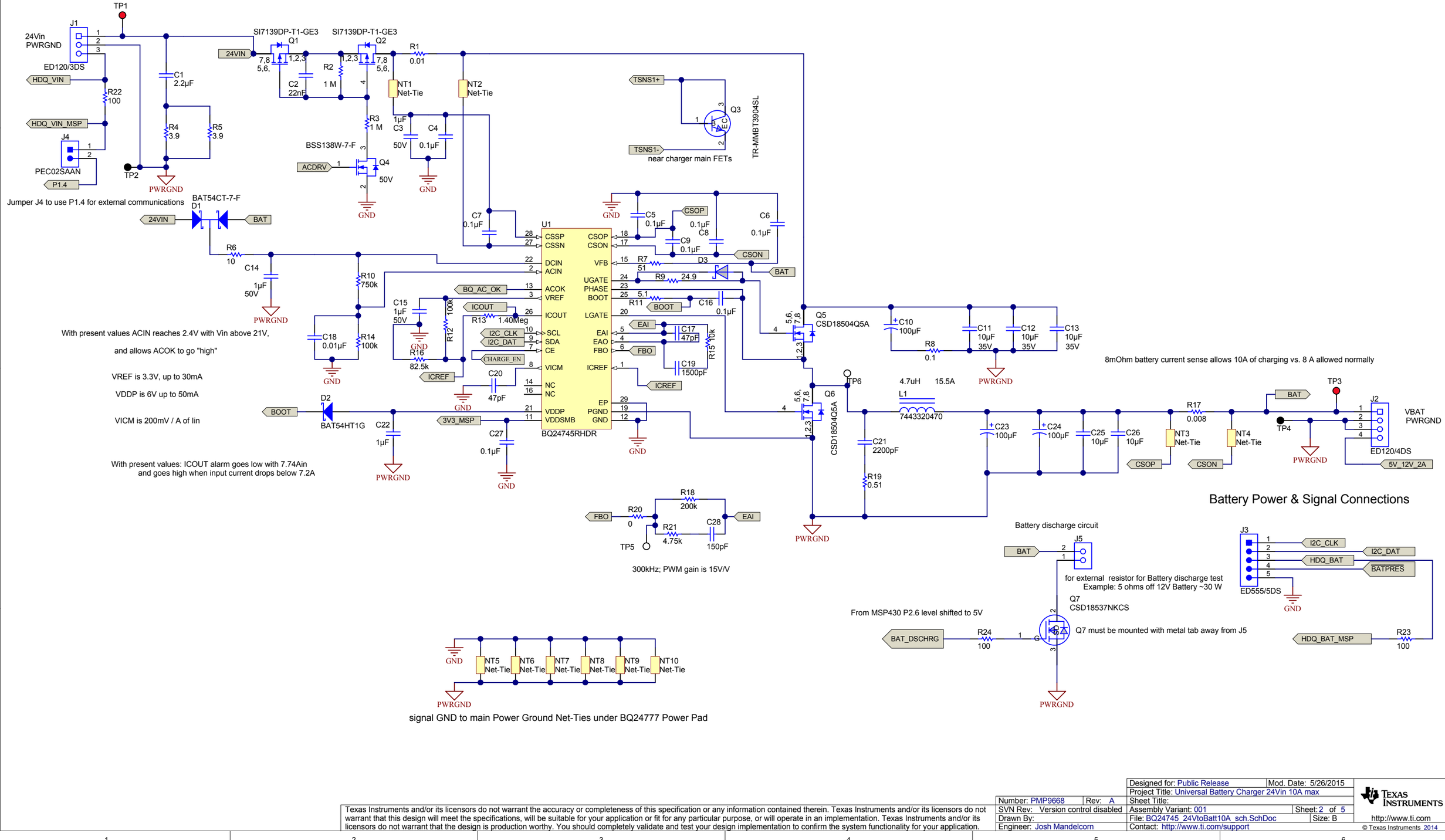

Number: PMP9668	Rev: A	Designed for: Public Release	Mod. Date: 5/26/2015
SVN Rev: Version control disabled		Project Title: Universal Battery Charger 24Vin 10A max	
Drawn By:		Sheet Title:	
Engineer: Josh Mandelcorn		Assembly Variant: 001	Sheet: 2 of 5
		File: BQ24745_24VtoBatt10A_sch.SchDoc	Size: B
		Contact: http://www.ti.com/support	

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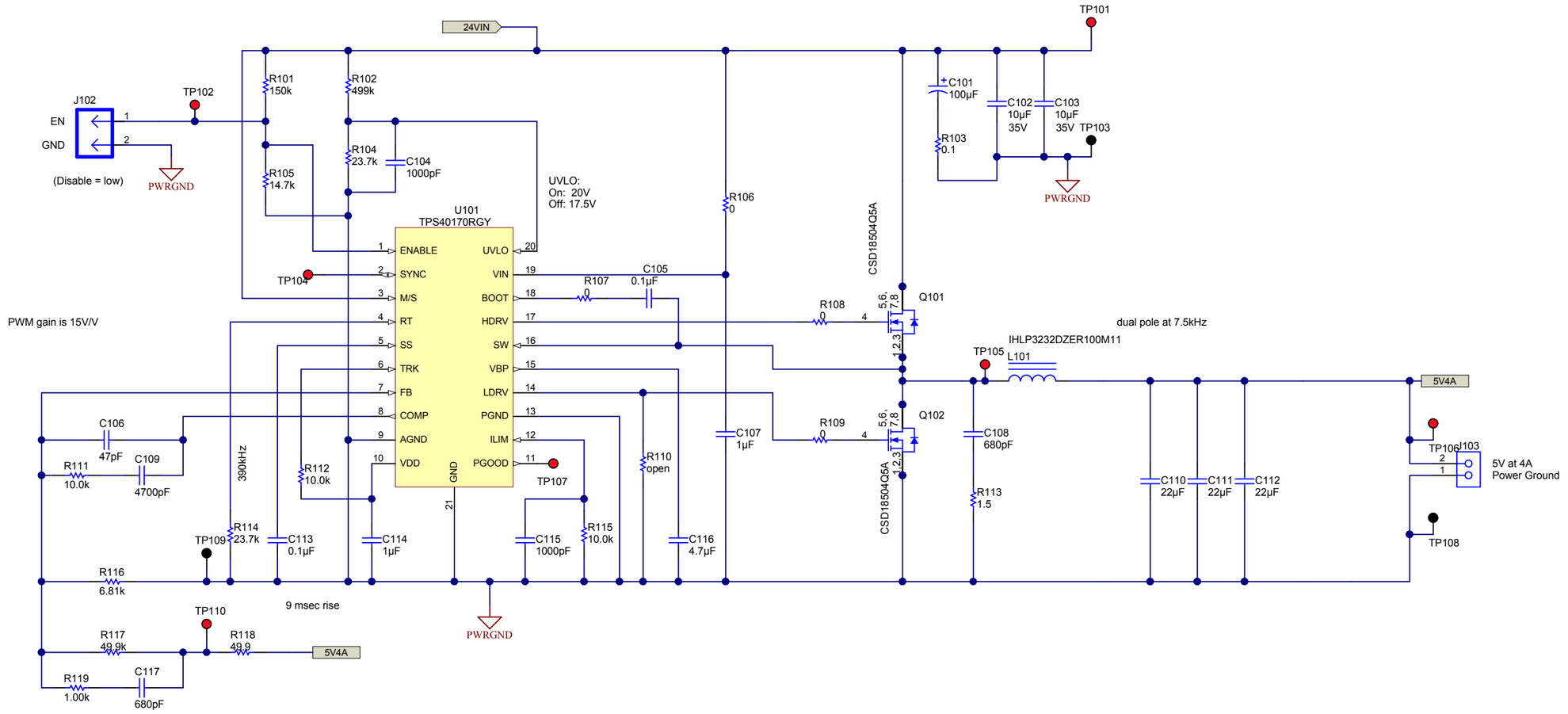

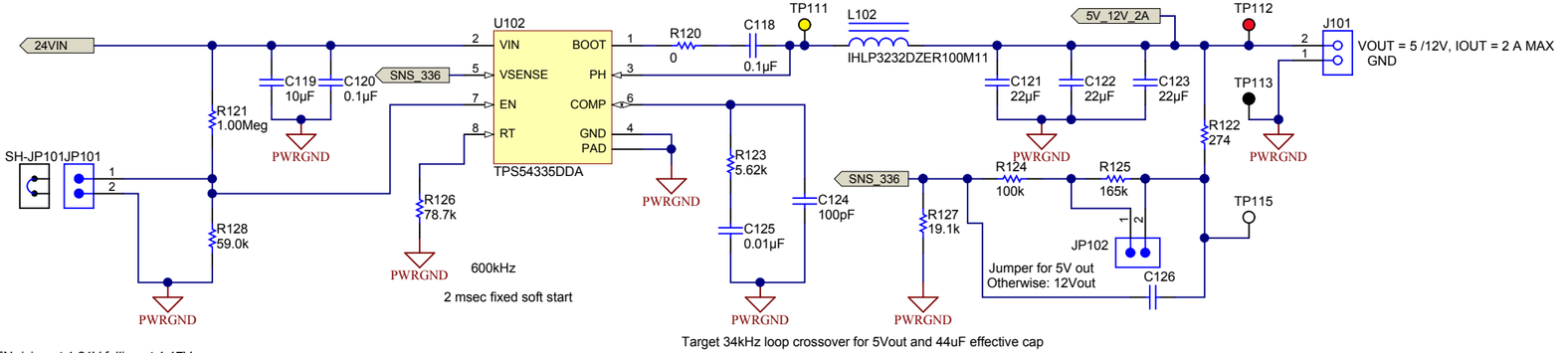

EN rising at 1.21V falling at 1.17V

EN source current: 1.15uA below threshold; 4.45uAabove threshold

typical rising at 20.5Vin and falling at 16.5Vin

Eroor amp Gm = 0.0013

Comp to Iswitch gain 8A/V

800mV ref; 2.3uA in Css 3.5msec rise for 10nF

Target 34kHz loop crossover for 5Vout and 44uF effective cap

If effective cap at 12Vout is 18uF; loop crossover will be same 34kHz

Designed for: Public Release		Mod. Date: 4/9/2014	
Project Title: Universal Battery Charger 24Vin 10A max			
Number: PMP9668	Rev: A	Sheet Title:	
SVN Rev: Version control disabled		Assembly Variant: 001	Sheet: 3 of 5
Drawn By:		File: 5V&12V_sch.SchDoc	Size: B
Engineer: Josh Mandelcorn		Contact: http://www.ti.com/support	

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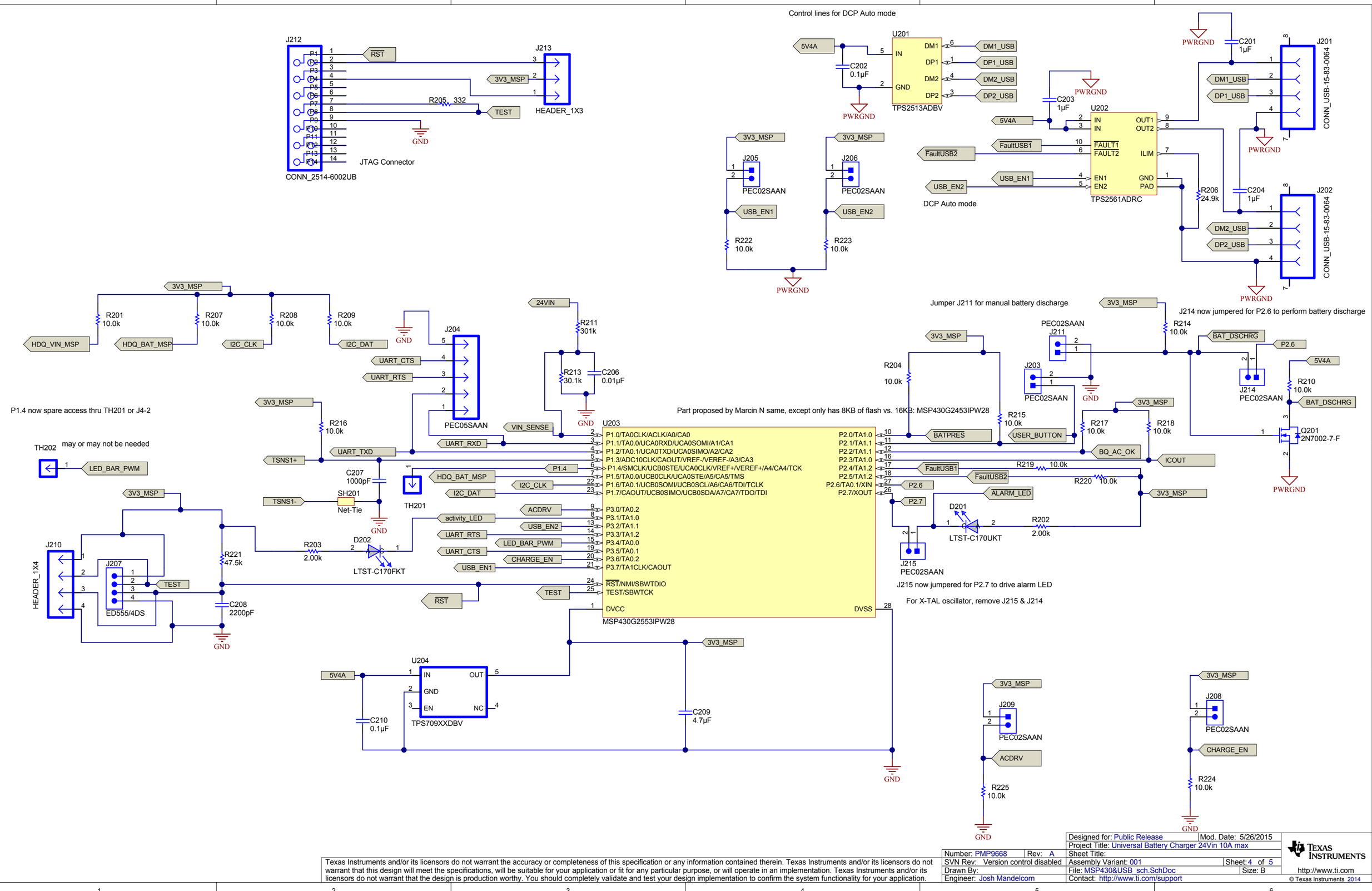

Number: PMP9668	Rev: A	Designed for: Public Release	Mod. Date: 5/26/2015
SVN Rev: Version control disabled		Project Title: Universal Battery Charger 24Vin 10A max	
Drawn By:		Sheet Title:	
Engineer: Josh Mandelcorn		Assembly Variant: 001	Sheet: 4 of 5
		File: MSP430&USB_sch.SchDoc	Size: B
		Contact: http://www.ti.com/support	

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H1
NY PMS 440 0025 PH

H2
NY PMS 440 0025 PH

H3
NY PMS 440 0025 PH

H4
NY PMS 440 0025 PH

H5
1902C

H6
1902C

H7
1902C

H8
1902C

DNP
FID1

DNP
FID2

DNP
FID3

PCB Number: PMP9668
PCB Rev: A

PCB
LOGO
Texas Instruments

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1
PCB Label
Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Number: PMP9668	Rev: A	Designed for: Public Release	Mod. Date: 5/26/2015
		Project Title: Universal Battery Charger 24Vin 10A max	
		Sheet Title:	
SVN Rev: Version control disabled		Assembly Variant: 001	Sheet: 5 of 5
Drawn By:		File: Hardware_PMP9668A_sch.SchDoc	Size: B
Engineer: Josh Mandelcorn		Contact: http://www.ti.com/support	

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